

Multilayer Ceramic Chip Capacitors

CGA8P1X7R1C336M250KC



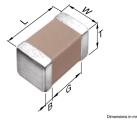






TDK item description CGA8P1X7R1C336MT****

Applications	Automotive Grade	
Feature	General General (Up to 50V) AEC-Q200 AEC-Q200	
Series	CGA8(4532) [EIA 1812]	
Status	Production (Not Recommended for New Design)	



	Size	
Length(L)	4.50mm ±0.40mm	
Width(W)	3.20mm ±0.40mm	
Thickness(T)	2.50mm ±0.30mm	
Terminal Width(B)	0.20mm Min.	
Terminal Spacing(G)		
Recommended Land Pattern (PA)	3.10mm to 3.70mm	
Recommended Land Pattern (PB)	1.20mm to 1.40mm	
Recommended Land Pattern (PC)	2.40mm to 3.20mm	

Electrical Characteristics		
Capacitance	33μF ±20%	
Rated Voltage	16VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	3ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	500pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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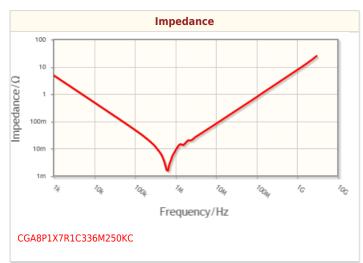




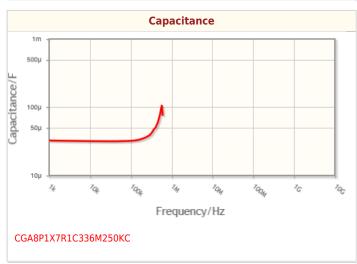


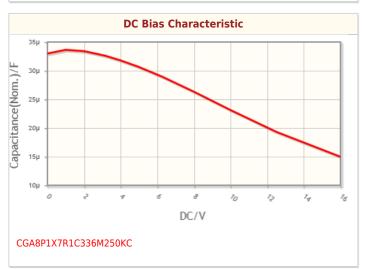


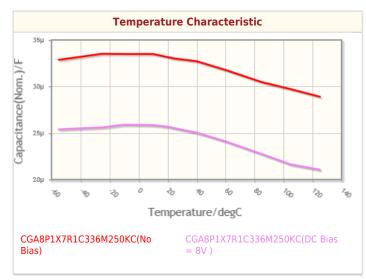
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

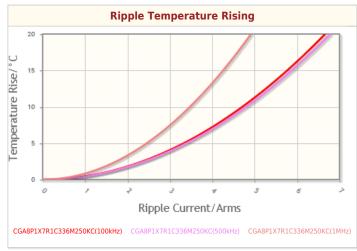












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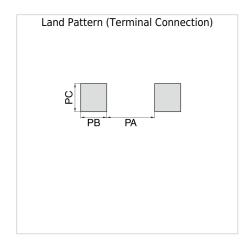








Associated Images



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